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To the Honorable Commissioner of P.

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Joriginal documents or copy thereof

Name of conveying party(ies):	2.	. Name and address of receiving party(ies):					
Howard E. Rhodes, Werner Juengling, The Figura and Steven D. Cummings	omas A. N	ame: Micron Technology, Inc.					
_	— 1	nternal Address:					
Additional name(s) of conveying party(ies) attached?	Yes X No S	treet Address: 8000 S. Federal Way					
3. Nature of Conveyance:		,, -					
X Assignment Merger	c	ity: Boise					
Security Agreement Change of N	Name S	tate: Idaho Zip: 83707-0006					
Other	c	ountry: United States of America					
Execution Date(s): June 24 and June 29,	~	Additional name(s) & Yes address(es) attached? x No					
4. Application number(s) or patent number	(s):						
If this document is being filed together with a the Execution date(s) of the new application		on, June 24, June 29 and July 10, 1999					
A. Patent Application No.(s):		Patent No.(s):					
	Δ	Additional numbers attached? Yes X No					
Name and address of party to whom corres concerning document should be mailed:		5. Total number of applications and 1 vatents involved:					
Name: DICKSTEIN SHAPIRO MORIN & OSHIN	ISKY LLP 7	7. Total fee (37 C.F.R 3.41) \$\$40.00					
Internal Address: Atty. Dkt.: M4065.0111/P1	11	x Enclosed					
Attn: Thomas J. D'Amico		Authorized to be charged to deposit account					
Street Address: 2101 L Street NW		Credit any overpayment or debit any underpayment					
City: State: Zip: Washington DC 20037-15	526	8. Deposit account number: 04-1073					
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Thomas J. D'Amico		July 22, 1999					
Reg. No. 28,371	nature	Date					
Total number of pages including cover	sheet, attachi	ments, and document: 9					

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ASSIGNMENT AND AGREEMENT

For value received, we, hereby sell, assign and transfer to Micron Technology, Inc., a corporation of the State of Delaware, having an office at 8000 S. Federal Way, Boise, Idaho 83706-9632, U.S.A., and its successors, assigns and legal representatives, the entire right, title and interest, for the United States of America, in and to certain inventions related to an entitled **OPTIMIZED** invention LOW LEAKAGE DIODES, INCLUDING PHOTODIODES, described in an application for Letters Patent of the United States, executed by us of even date herewith, and all the rights and privileges in said application and under any and all Letters Patent that may be granted in the United States for said inventions; and we also concurrently hereby sell, assign and transfer to Micron Technology, Inc. the entire right, title and interest in and to said inventions for all countries foreign to the United States, including all rights of priority arising from the application aforesaid, and all the rights and privileges under any and all forms of protection, including Letters Patent, that may be granted in said countries foreign to the United States for said inventions.

We authorize Micron Technology, Inc. to make application for such protection in its own name and maintain such protection in any and all countries foreign to the United States, and to invoke and claim for any application for patent or other form of protection for said inventions, without further authorization from us, any and all benefits, including the right of priority provided by any and all treaties, conventions, or agreements.

We hereby consent that a copy of this assignment shall be deemed a full legal and formal equivalent of any document which may be required in any country in proof of the right of Micron Technology, Inc. to apply for patent or other form of protection for said inventions and to claim the aforesaid benefit of the right of priority.

We request that any and all patents for said inventions be issued to Micron Technology, Inc. in the United States and in all countries foreign to the United States, or to such nominees as Micron Technology, Inc. may designate.

We agree that, when requested, we shall, without charge to Micron Technology, Inc. but at its expense, sign all papers, and do all acts which may be necessary, desirable or convenient in connection with said applications, patents, or other forms of protection.

Hown	ul Bo	(lede)
Date: 6/24/99		
United States of America		
State of Idaho)ss.:		
County of Qda)		
On this 24 day of June	, 1999	, before me
personally came Howard E. Rhodes	, to me know	n to be the
individual described in and who executed the foregoing in	strument, and ackn	owledged
execution of the same.	Brek	
N. S. BOVED DELLER	otary Public	
NOTARL *		

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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

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oignatui	e 1 age 101 occord inventor
2.	Morney Junglany
Date: 24-JUNE-1999	
United States of America)
State of Idaho)ss.:
County of <u>Oda</u>	
On this 24 day of	, 1999 , before me
personally came Werner Juengling	<u> </u>
ndividual described in and who execu	ited the foregoing instrument, and acknowledged
execution of the same.	Notary Public
AOTAAL ***	

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

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Signature Page for Third Inventor

				_
Date:		_		
): 	ss.:		
On this	day of _		, 1999	_ , before me
	Thomas A. Figura		, to me know	
ndividual described execution of the sa		d the foregoing instrum	ent, and ackno	owledged
		Notary	Public	·····

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

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Signature Page for Fourth Inventor

Date: 6-29-99	
United States of America)	
State of Idaho)ss.:	
County of (da)	
	<i>ne</i> , <u>1999</u> , before me
personally came Steven D. Cumming	, to me known to be the
individual described in and who executed the for	regoing instrument, and acknowledged
execution of the same.	lesa Roser
	Notary Public
NOTARY *	

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For value received, we, hereby sell, assign and transfer to Micron Technology, Inc., a corporation of the State of Delaware, having an office at 8000 S. Federal Way, Boise, Idaho 83706-9632, U.S.A., and its successors, assigns and legal representatives, the entire right, title and interest, for the United States of America, in and to certain inventions related to an invention entitled OPTIMIZED LOW LEAKAGE DIODES, INCLUDING PHOTODIODES, described in an application for Letters Patent of the United States, executed by us of even date herewith, and all the rights and privileges in said application and under any and all Letters Patent that may be granted in the United States for said inventions; and we also concurrently hereby sell, assign and transfer to Micron Technology, Inc. the entire right, title and interest in and to said inventions for all countries foreign to the United States, including all rights of priority arising from the application aforesaid, and all the rights and privileges under any and all forms of protection, including Letters Patent, that may be granted in said countries foreign to the United States for said inventions.

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Date:								
United States	s of Am	erica)					
State of	ate of Idaho)ss.:					
County of)					
O	n this	d	ay of			,	1999	, before me
personally ca	ime	Howard E. F	Rhodes			- , t	o me know	n to be the
individual de execution of		in and who ex	recuted the	foregoing	instrument	, and	d acknowle	dged
					Notary	/ Pu	blic	

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

ASSIGNMENT AND AGREEMENT

Signature Page for Third Inventor

Data		\mathcal{I}	homas (. trge	na
Date:					
))ss.:			
)			
On this	day of		·	1999	, before me
personally came	Thomas A. Figura		, t	o me knowr	to be the
ndividual describe execution of the sar	d in and who executed me.	d the foregoin	g instrument, an	d acknowled	dged
			Notary Pu	ıblic	

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